## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

`	therewith are being deposited with the United States Postal Service as first class
Serial No.: To be assigned	mail, postage prepaid, on June 25, 2003
Filed: June 25, 2003	in an envelope addressed to Commissioner for Patents, P.O. Box
For: CMP Slurry Compositions for Oxide Films and Methods for Forming Metal Line Contact Plugs Using the Same )	Michael R. Hull Reg. No. 35,902 Attorney for Applicant
Group Art Unit: To be assigned )	

Examiner: To be assigned

## INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents P.O. Box 1450 Alexandria, Virginia 22313-1450

Sir:

Submitted herewith for consideration by the examiner are copies of the documents identified on the attached PTO-1449. Entry and consideration of the submitted documents is solicited.

The Commissioner is authorized to charge any fee deficiency required by this paper, or credit any overpayment, to Deposit Account No. 13-2855. A copy of this paper is enclosed.

Respectfully submitted,

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June 25, 2003

By:

Michael R. Hul

Reg. No. 35,902

For m PTO-1449 (Modified)	U.S. Department of Commerce	Atty. Docket No.	Serial No.	
	Patent and Trademark Office	30205/39380	To be assigned	
		Applicants		
INFORMATION DIS	CLOSURE STATEMENT	Jong Goo Jung and Sang Ick Lee		
		Filing Date	Group	
		June 25, 2003	To be assigned	

U.S. PATENT DOCUMENTS						
*Examiner Initials	Document Number	Issue Date	Name	Class	Subclass	Filing Date if Appropriate
	6,436,834 B1	08/20/02	Lee et al.			
	6,468,910 B1	10/22/02	Srinivasan et al.			

FOREIGN PATENT DOCUMENTS								
*Examiner Initials		Document Number	Publication Date	Country	Class	Subclass	Translation	
							Yes	No

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, etc.)					

EXAMINER	DATE CONSIDERED	

\*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.